



Liu et al
USSN 09/208,963
Filed Dec. 10, 1998

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of)
John Liu et al) Examiner Harry D. Wilkins, III *#13*
Serial No. 09/208,963) Group Art Unit 1742 *11*
Filed December 10, 1998) Attorney Docket 97-2739 *20*
For High Toughness Plate Alloy)
for Aerospace Applications) *2/28/01*

Amendment

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231 on February 28, 2001.

Charles Q. Buckwalter
Charles Q. Buckwalter, Reg. No. 32969
Date of Signature: February 28, 2001

Assistant Commissioner for Patents
Box RCE
Washington, DC 20231

Sir:

The following is in response to the Office Action dated January 19, 2001.

In the claims:

In accordance with 37 CFR 1.121:

- (a) a marked form version of the amended claims is presented in the "Marked Claims" attached to this Amendment; and
- (b) a clean form version of the amended claims is presented below.

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